

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
NAOKI YOKOYAMA	08/08/2019
NAOYA HAMADA	08/08/2019
TOMOHIRO SHIBASAKI	08/08/2019
RECEIVING PARTY DATA	
Name:	TAISEI LAMICK CO., LTD.
Street Address:	873-1, SHIMO-OHSAKI, SHIRAOKA-SHI
City:	SAITAMA
State/Country:	JAPAN
Postal Code:	349-0293
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16580599
CORRESPONDENCE DATA	
Fax Number:	(703)716-1180
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	703-716-1191
Email:	gbpatent@gbpatent.com
Correspondent Name:	GREENBLUM & BERNSTEIN, P.L.C.
Address Line 1:	1950 ROLAND CLARKE PLACE
Address Line 4:	RESTON, VIRGINIA 20191
ATTORNEY DOCKET NUMBER:	P58829
NAME OF SUBMITTER:	DANIEL B. MOON
SIGNATURE:	/Daniel B. Moon/
DATE SIGNED:	09/24/2019
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 4	
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ASSIGNMENT

WHEREAS, **Naoki YOKOYAMA**, a resident of Shiraoka-shi, Saitama, JAPAN, whose mailing address is c/o Taisei Lamick Co., Ltd., 873-1 Shimo-Ohsaki, Shiraoka-shi, Saitama 349-0293, JAPAN, **Naoya HAMADA**, a resident of Shiraoka-shi, Saitama, JAPAN, whose mailing address is c/o Taisei Lamick Co., Ltd., 873-1 Shimo-Ohsaki, Shiraoka-shi, Saitama 349-0293, JAPAN, **Tomohiro SHIBASAKI**, a resident of Shiraoka-shi, Saitama, JAPAN, whose mailing address is c/o Taisei Lamick Co., Ltd., 873-1 Shimo-Ohsaki, Shiraoka-shi, Saitama 349-0293, JAPAN, hereinafter referred to as the ASSIGNORS, have invented a certain improvement relating to

JOINT TAPE, METHOD AND APPARATUS FOR CONNECTION OF PACKING FILM UTILIZING THE SAME

for which they have jointly executed, on the same date as this assignment, an application for Letters Patent for the United States to be filed in the United States Patent and Trademark Office.

AND WHEREAS, **TAISEI LAMICK CO., LTD.**, a corporation organized and existing under the laws of JAPAN, whose mailing address is 873-1, Shimo-Ohsaki, Shiraoka, Saitama 349-0293, JAPAN, hereinafter known as the ASSIGNEE, is desirous of acquiring the entire right, title and interest for the United States in and to said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, reexaminations, and prolongations thereof.

NOW, THIS WITNESSETH that for good and valuable consideration, the receipt whereof is hereby acknowledged, said ASSIGNORS hereby assign, sell and transfer to said ASSIGNEE, its assigns and legal representatives, the entire and exclusive right, title and interest in and to said invention and application, for the United States including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted therefor and all rights to sue for past and future infringement thereunder, said ASSIGNEE and its assigns and legal representatives to have, hold, exercise and enjoy the said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, reexaminations, and prolongations thereof, with all the rights, powers, privileges, and advantages in any ways arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues, reexaminations, and prolongations thereof, for the use and benefit of said ASSIGNEE and its assigns and legal representatives in as ample and beneficial a manner to all intents and purposes as the said ASSIGNORS might or could have held and enjoyed the same, if this assignment had not been made.

AND said ASSIGNORS hereby agree to execute all papers necessary to file applications in the United States for said invention and to assign the same to said ASSIGNEE, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing Letters Patent thereon.

AND said ASSIGNORS authorize and request the Commissioner of Patents to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEE, its assigns and legal representatives, in accordance herewith.

IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNOR(S), on the respective date(s) indicated below.

First Witness:

Takuya Nakayama
(Name) Takuya NAKAYAMA

8/8/2019
(Date)

Naoki YOKOYAMA
Naoki YOKOYAMA

8/8/2019
Date

Second Witness:

Katsumasa ISHIDA
(Name) Katsumasa ISHIDA

8/8/2019
(Date)

IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNOR(S), on the respective date(s) indicated below.

First Witness:

Takuya Nakayama.
(Name) Takuya NAKAYAMA

8 / 8 / 2019.
(Date)

Naoya HAMADA
Naoya HAMADA
8 / 8 / 2019
Date

Second Witness:

Katsumasa ISHIDA
(Name) Katsumasa ISHIDA

8 / 8 / 2019
(Date)

IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNOR(S), on the respective date(s) indicated below.

First Witness:

Takuya Nakayama.
(Name) Takuya NAKAYAMA

8/8/2019.
(Date)

Tomohiro Shibasaki
Tomohiro SHIBASAKI
8/8/2019
Date

Second Witness:

Katsumasa ISHIDA
(Name) Katsumasa ISHIDA

8/8/2019
(Date)